

■ Description

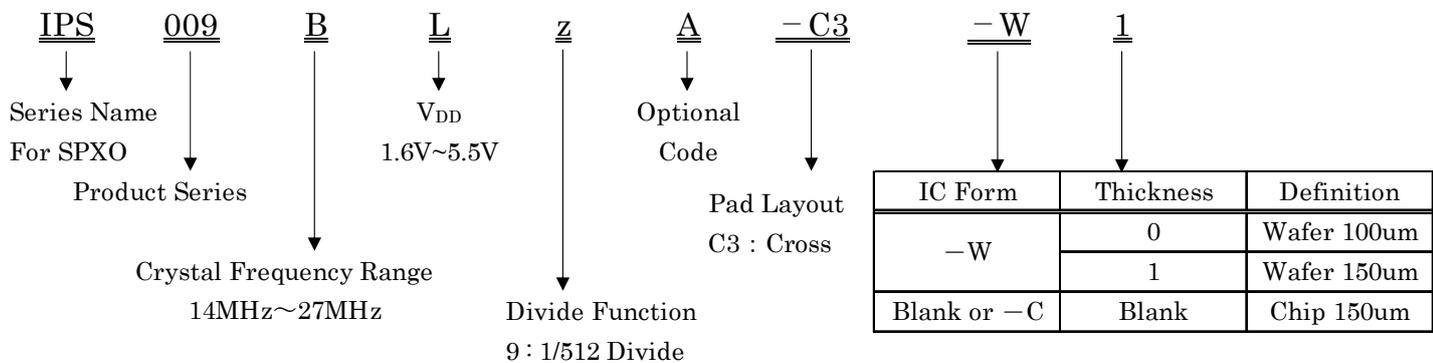
IPS009BL9 and IPS009BL9A are the specific SPXO IC for achieving 32.768kHz output by divide, corresponding to the fundamental crystal from 14MHz to 27MHz corresponding to each IC.

The power consumption of these IC is quite low, so IPS009BL9 and IPS009BL9A suit for mobile application.

■ Features

- Divide function : 1/512
- Crystal frequency : 14MHz to 27MHz
- Operation temperature : -40°C~125°C
- Power supply voltage : 1.6V~5.5V
- Standby function : Oscillation stop
- Output : CMOS
- Small chip size : 0.70mm × 0.75mm
- Frequency stability to Vdd : Within ±1ppm
- Duty cycle : Within 50%±5%

1. Part number rule



2. Series

Part Number	Crystal Frequency f (MHz)		Divide	Output Frequency FO (kHz)		Pad Layout	V _{DD} (V)	Remarks
	Min.	Max.		Min.	Max.			
IPS009 BL 9 -C3	16.777		1/512	32.768		Cross	1.62 ~5.5	AT-cut Crystal
IPS009 BL 9 A -C3	14.000	27.000		27.3	52.7			

3. Absolute Maximum Ratings

 $V_{SS}=0V, T_a=25^{\circ}C\pm 2^{\circ}C$

Parameter	Symbol	Condition	Ratings		Unit
			Min	Max	
Supply Voltage	V _{DD}		V _{SS} -0.5	7.0	V
Input Voltage	V _{IN}	All Input Pin	V _{SS} -0.5	V _{DD} +0.5	V
Output Voltage	V _{OUT}		V _{SS} -0.5	V _{DD} +0.5	V
Output Current	I _{OUT}			25	mA
Junction Temperature	T _j		-55	150	°C
Storage Temperature	T _{stg}		-55	125	°C

4. Recommended Operating Condition

 $V_{SS}=0V, T_a=-40^{\circ}C\sim 125^{\circ}C$

Parameter	Symbol	Condition		Min	Typ	Max	Unit	Note
Supply Voltage	V _{DD}			1.6	3.3	5.5	V	V _{DD}
“H” Input Voltage	V _{IH}			V _{DD} ×0.7			V	CE
“L” Input Voltage	V _{IL}					V _{DD} ×0.3	V	CE
Input Voltage	V _{IN}			V _{SS}		V _{DD}	V	CE
Output Load Capacitance	CL	CMOS	IPS009BL9			30	pF	OUT
			IPS009BL9A			15		
Ambient Temperature	Topt			-40		125	°C	

This IC has enough immunity against ESD and Latch-up, but handle with care.

5. Electrical Specification
5-1 IPS009BL9

 Unless otherwise stated, $V_{DD}=1.6V\sim 5.5V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 125^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
Out put Leak current	I_z	CE=0V, X1= V_{DD} , V_{SS} $V_{out}=V_{SS}\sim V_{DD}$			20	μA
“H” input current	I_{IH}	CE pad, $V_{IH}=V_{DD}$		0.01	0.15	μA
“L” input current	I_{IL}	CE pad, $V_{IL}=0V$	-1.45	-1.25		
Output Disable Time	T_{plz}	OUT pad			0.1	μs
Output Enable Time	T_{pzl}	OUT pad			2.0	ms
Osc. start up time	T_{start}	$V_{DD}>1.6V$			2.0	ms
“H” output voltage	V_{OH}	OUT pad, $I_{OH}=-1.0mA$	$0.9V_{DD}$			V
“L” output voltage	V_{OL}	OUT pad, $I_{OL}=1.0mA$			$0.1V_{DD}$	V
Current consumption *CE $\geq V_{DD}-0.3V$ f=16.777MHz	I_{DD}	CL=15pF, $V_{DD}=3.63V$		56	115	μA
		CL=15pF, $V_{DD}=5.5V$		64	130	
		CL=30pF, $V_{DD}=1.8V$		52	110	
		CL=30pF, $V_{DD}=3.63V$		58	120	
		CL=30pF, $V_{DD}=5.5V$		67	140	
Current consumption at oscillation disable	I_{DDD}	CL=15pF, $V_{DD}=3.3V$ CE $\leq 0.3V$		1.0	3.0	μA
Freq. V_{DD} deviation	F_{vst}	$V_{DD}=3.3\pm 10\%$			± 1.0	ppm
Output Duty Ratio	Duty	1/2 V_{DD} point	45		55	%
Rise/Fall time	T_r/T_f	10%~90% V_{DD} , CL=15pF $V_{DD}=1.62V\sim 2.5V$		5.5	14.0	ns
		10%~90% V_{DD} , CL=15pF $V_{DD}=2.5V\sim 5.5V$		3.0	10.0	
		10%~90% V_{DD} , CL=30pF $V_{DD}=1.62V\sim 2.5V$		8.0	18.0	
		10%~90% V_{DD} , CL=30pF $V_{DD}=2.5V\sim 5.5V$		5.0	13.0	

5-2 IPS009BL9A

 Unless otherwise stated, $V_{DD}=1.6V\sim 5.5V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 125^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
Out put Leak current	I_z	$CE=0V$, $X1=V_{DD}$, V_{SS} $V_{out}=V_{SS}\sim V_{DD}$			20	μA
“H” input current	I_{IH}	CE pad, $V_{IH}=V_{DD}$		0.01	0.15	μA
“L” input current	I_{IL}	CE pad, $V_{IL}=0V$	-1.45	-1.25		
Output Disable Time	T_{plz}	OUT pad			0.1	μs
Output Enable Time	T_{pzl}	OUT pad			2.0	ms
Osc. start up time	T_{start}	$V_{DD}>1.6V$			2.0	ms
“H” output voltage	V_{OH}	OUT pad, $I_{OH}=-0.4mA$	$0.9V_{DD}$			V
“L” output voltage	V_{OL}	OUT pad, $I_{OL}=0.4mA$			$0.1V_{DD}$	V
Current consumption	I_{DD}	No Load, $V_{DD}=3.63V$ $f=16.777MHz$, $CE\geq V_{DD}-0.3V$		38	58	μA
		No Load, $V_{DD}=5.5V$ $f=16.777MHz$, $CE\geq V_{DD}-0.3V$		45	80	
		No Load, $V_{DD}=3.63V$ $f=27MHz$, $CE\geq V_{DD}-0.3V$		64	97	
		No Load, $V_{DD}=5.5V$ $f=27MHz$, $CE\geq V_{DD}-0.3V$		75	120	
Current consumption at oscillation disable	I_{DDD}	$CL=15pF$, $V_{DD}=3.3V$ $CE\leq 0.3V$		1.0	3.0	μA
Freq. V_{DD} deviation	F_{vst}	$V_{DD}=3.3\pm 10\%$			± 1.0	ppm
Output Duty Ratio	Duty	$1/2V_{DD}$ point	45		55	%
Rise/Fall time	T_r/T_f	$10\%\sim 90\%V_{DD}$, $CL=15pF$ $V_{DD}=1.62V\sim 2.5V$		14.0	21.0	ns
		$10\%\sim 90\%V_{DD}$, $CL=15pF$ $V_{DD}=2.5V\sim 5.5V$		8.0	12.0	

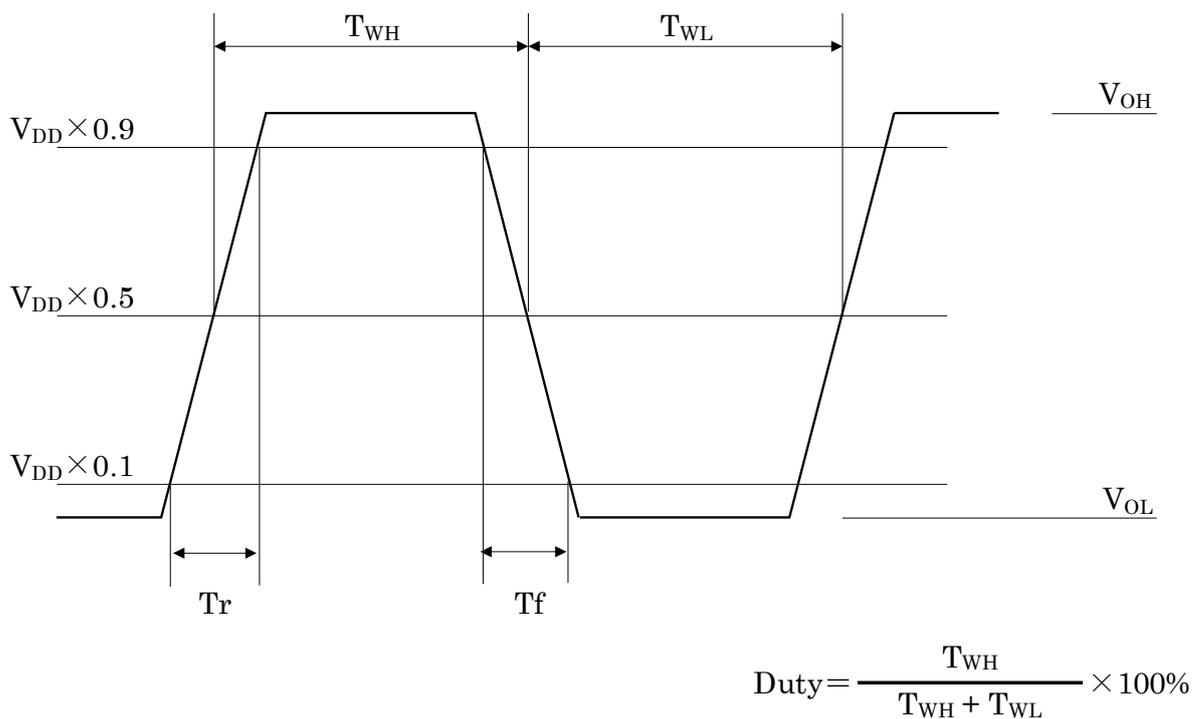
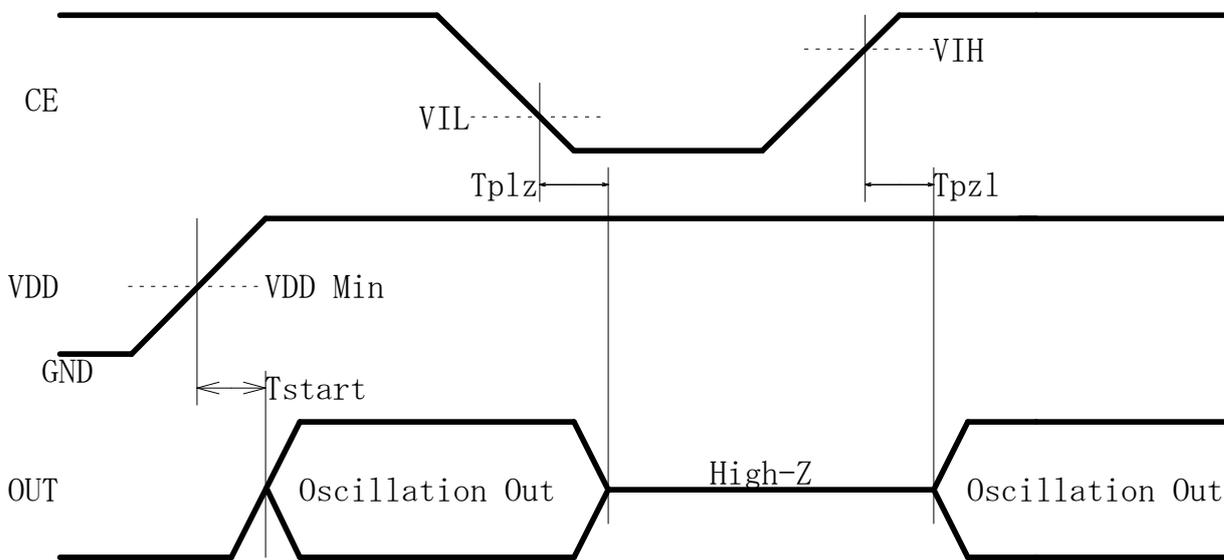


Fig. 5-1 Output wave form (Duty, Tr, Tf, VOH, VOL)



V_{IH} : Threshold voltage for Oscillation Start
 V_{IL} : Threshold voltage for Oscillation Stop

Fig. 5-2 Input output signal timing

6. Circuit Parameters of Oscillator (Reference Data for Circuit Design)
 $T_a=25^{\circ}\text{C}$

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Equivalent series (Loading) Capacitance	CLxtal	$V_{DD}=3.3\text{V}$, $f=16\text{MHz}$		3.3		pF
Drive Level	IPS009BL9	$V_{DD}=3.3\text{V}$, $f=16\text{MHz}$		15		μW
	IPS009BL9A			1.7		
Feedback Resistor	Rf			300		k Ω
Driving Resistor	IPS009BL9			600		Ω
	IPS009BL9A			1000		
Oscillation Capacitor				6.0		pF
	IPS009BL9			8.0		pF
	IPS009BL9A			2.0		

*The above values are the design values and are not guaranteed by test.

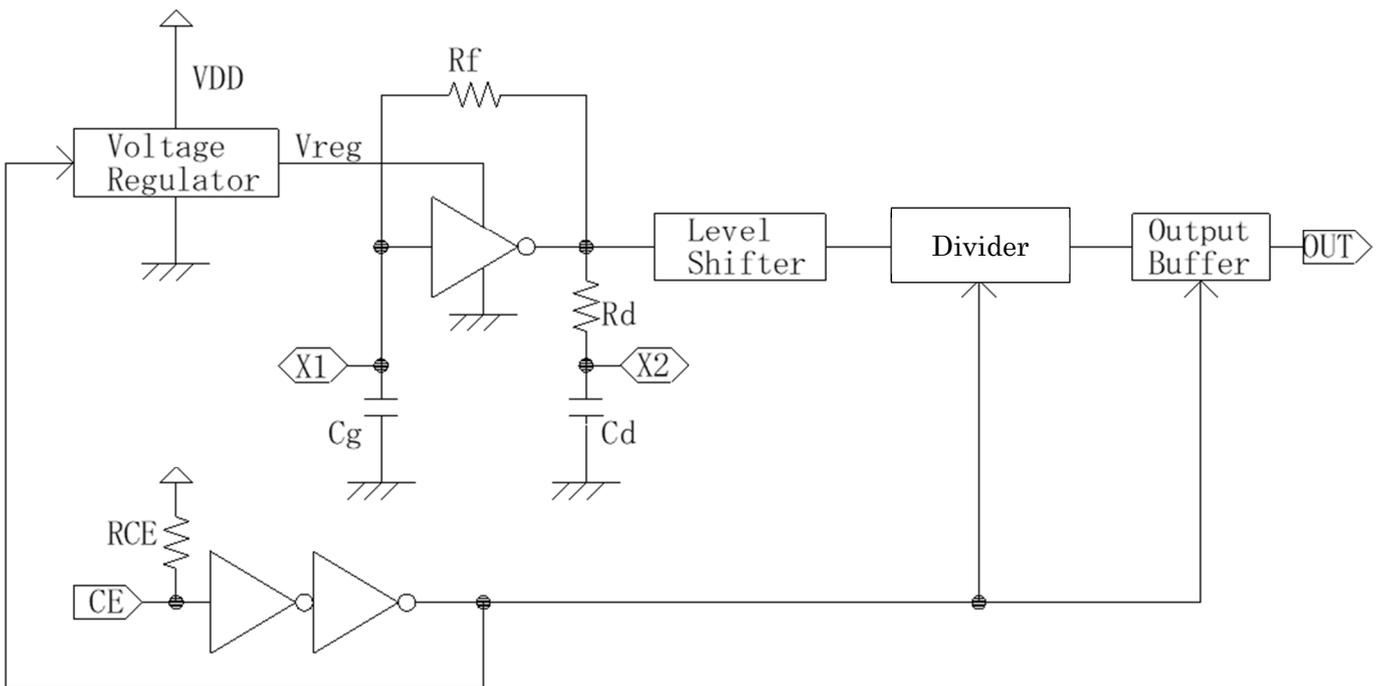
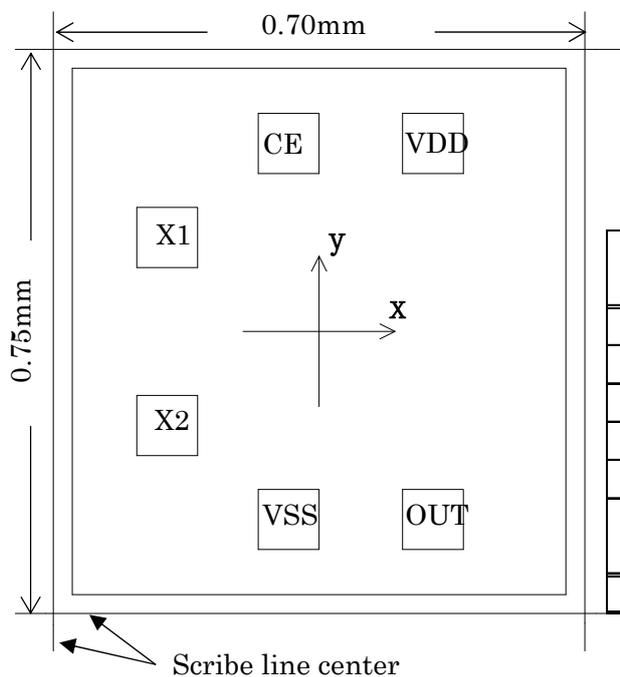


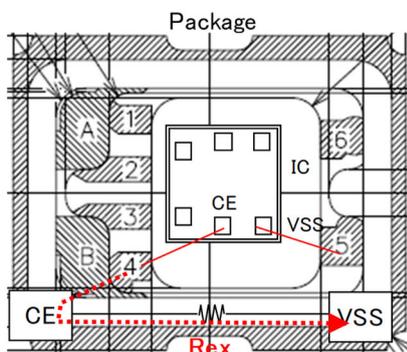
Fig. 6-1 Block Diagram

7. Pad Layout



- Die Size: 0.70mm × 0.75mm
- Pad Size: 80μm □
- Thickness: 150μm±20μm
- IC Backside: Gnd or Open

Pad Name	Function	Location (μm)	
		x	y
VDD	(+) Power Supply	152	244
OUT(Q)	Frequency Output	152	-244
VSS	(-) Ground	-39	-244
X2	Crystal Drive	-209	-133
X1	Crystal Feedback	-209	133
CE	Oscillation stop "L": High-Impedance	-39	244
Chip Center		0	0



IMPORTANT Notice for CE function

- ※ Oscillation will not be activated when CE=Open after CE=Low if Rex is not large.
- ※ Reference value of Rex is over 10MΩ with CE=Open usage.
- ※ There is no such issue with CE=VDD usage.

Rex : Resistance value between CE and VSS of package

